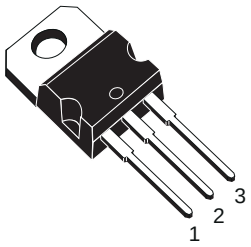
BUL38D

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- STMicroelectronics PREFERRED SALESTYPE
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- LOW BASE-DRIVE REQUIREMENTS
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERISED AT 125°C
- HIGH RUGGEDNESS
- INTEGRATED ANTIPARALLEL COLLECTOR-EMITTER DIODE



TO-220

APPLICATIONS

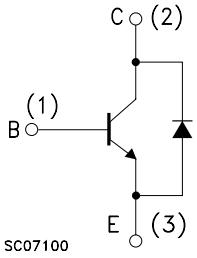
- ELECTRONIC TRANSFORMERS FOR HALOGEN LAMPS
- SWITCH MODE POWER SUPPLIES

DESCRIPTION

The BUL38D is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and high voltage withstand capability.

The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.

INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage (V_{BE} = 0)	800	V
V_{CEO}	Collector-Emitter Voltage (I_B = 0)	450	V
V_{EBO}	Emitter-Base Voltage (I_C = 0)	9	V
I_C	Collector Current	5	V
I_{CM}	Collector Peak Current (t_p <5 ms)	10	A
I_B	Base Current	2	A
I_{BM}	Base Peak Current (t_p <5 ms)	4	A
P_{tot}	Total Dissipation at Tc = 25 °C	80	W
T_{stg}	Storage Temperature	-65 to 150	°C
T_j	Max. Operating Junction Temperature	150	°C

THERMAL DATA

$R_{thj\text{-}case}$	Thermal Resistance Junction-Case	Max	1.56	°C/W
$R_{thj\text{-}amb}$	Thermal Resistance Junction-Ambient	Max	62.5	°C/W

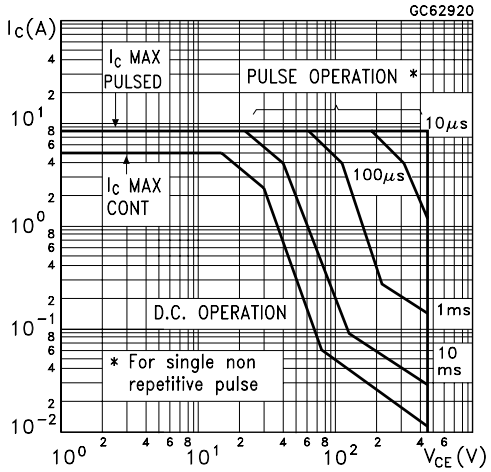
ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector Cut-off Current (V_{BE} = 0)	V_{CE} = 800 V V_{CE} = 800 V T_c = 125 °C			100 500	µA µA
I_{CEO}	Collector Cut-off Current (I_B = 0)	V_{CE} = 450 V			250	µA
$V_{CEO(sus)}$*	Collector-Emitter Sustaining Voltage (I_B = 0)	I_C = 100 mA L = 25 mH	450			V
V_{EBO}	Emitter-Base Voltage (I_C = 0)	I_E = 10 mA	9			V
$V_{CE(sat)}$*	Collector-Emitter Saturation Voltage	I_C = 1 A I_B = 0.2 A I_C = 2 A I_B = 0.4 A I_C = 3 A I_B = 0.75 A			0.5 0.7 1.1	V V V
$V_{BE(sat)}$*	Base-Emitter Saturation Voltage	I_C = 1 A I_B = 0.2 A I_C = 2 A I_B = 0.4 A			1.1 1.2	V V
h_{FE}*	DC Current Gain	I_C = 10 mA V_{CE} = 5 V I_C = 0.5 A V_{CE} = 5 V I_C = 2 A V_{CE} = 5 V Group A Group B	10 13 22		 60 23 32	
t_s t_f	RESISTIVE LOAD Storage Time Fall Time	I_C = 2.5 A V_{CC} = 150 V I_{B1} = -I_{B2} = 0.5 A t_p = 30 µs (see figure 2)	1.0		2.2 0.8	µs µs
t_s t_f	INDUCTIVE LOAD Storage Time Fall Time	I_C = 2 A I_{B1} = 0.4 A $V_{BE(off)}$ = -5 V R_{BB} = 0 Ω V_{CL} = 250 V L = 200 µH (see figure 1)		1 55	1.8 100	µs ns
t_s t_f	INDUCTIVE LOAD Storage Time Fall Time	I_C = 2 A I_{B1} = 0.4 A $V_{BE(off)}$ = -5 V R_{BB} = 0 Ω V_{CL} = 250 V L = 200 µH T_c = 125 °C (see figure 1)		1.3 100		µs ns
V_f	Diode Forward Voltage	I_C = 2 A			1.5	V

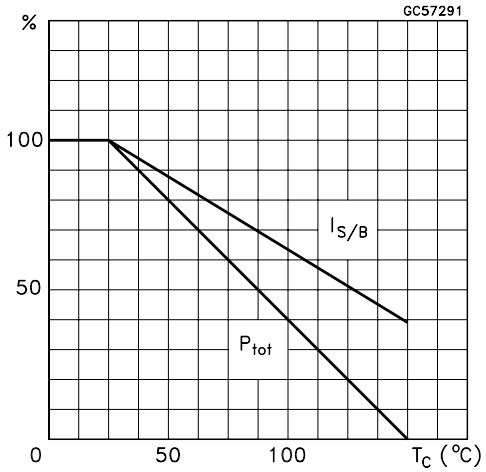
∗ Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.

The product is pre-selected in DC current gain (Group A and Group B). STMicroelectronics reserves the right to ship either groups according to production availability. Please contact your nearest STMicrolectronics sales office for delivery datails.

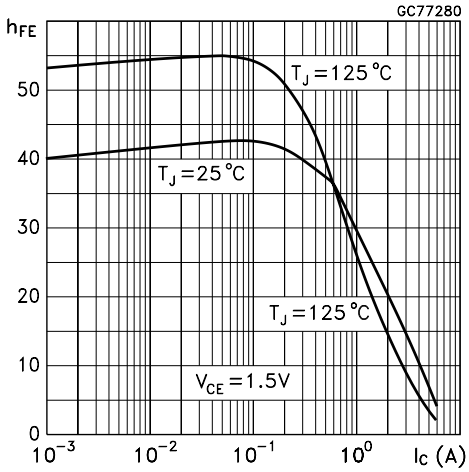
Safe Operating Area



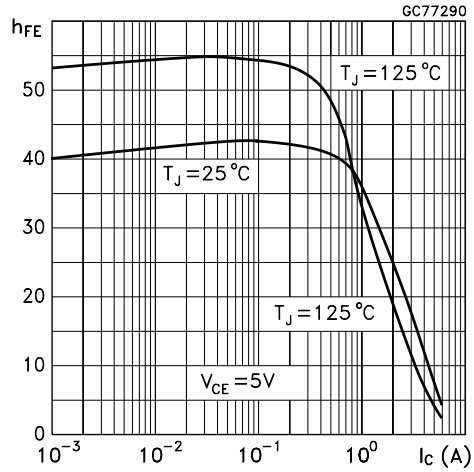
Derating Curve



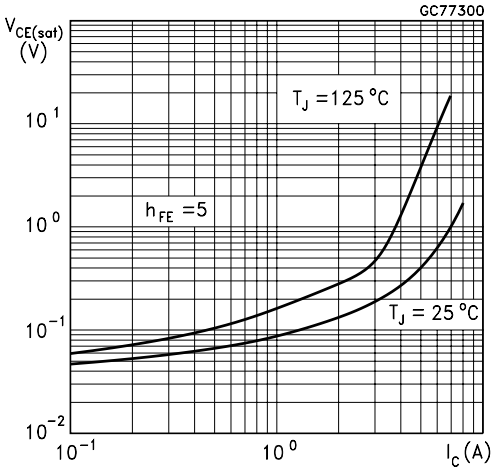
DC Current Gain



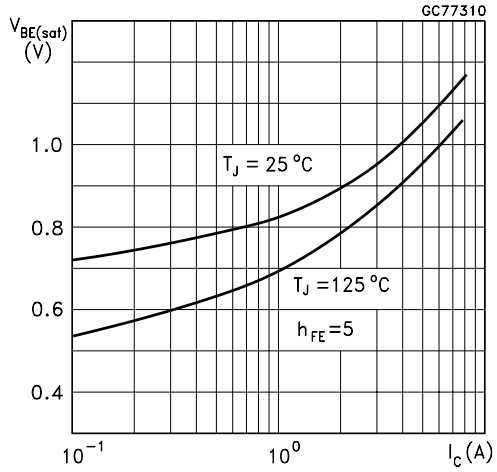
DC Current Gain



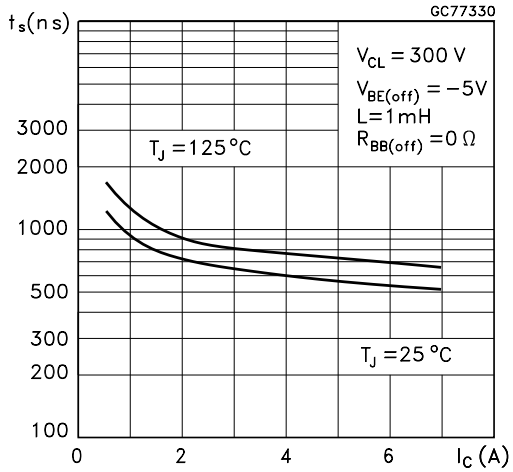
Collector-Emitter Saturation Voltage



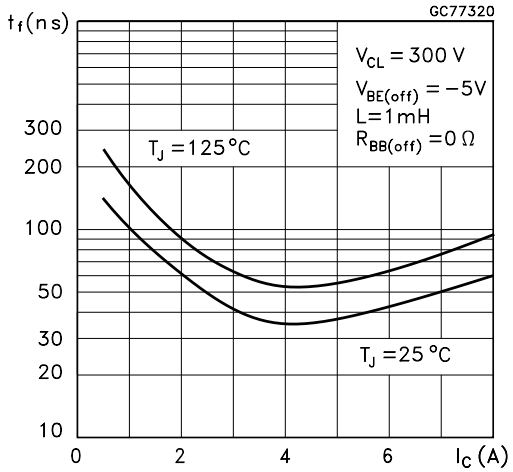
Base-Emitter Saturation Voltage



Inductive Load Storage Time



Inductive Load Fall Time



Reverse Biased SOA

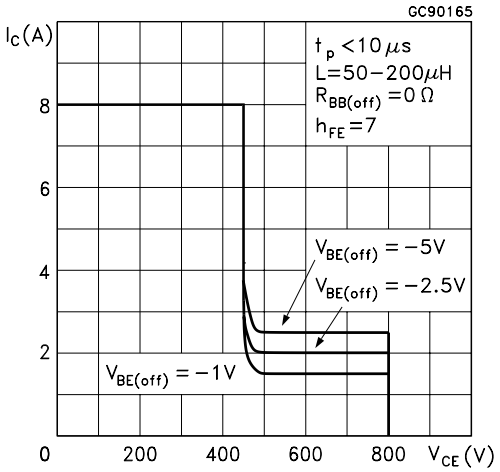


Figure 1: Inductive Load Switching Test Circuit.

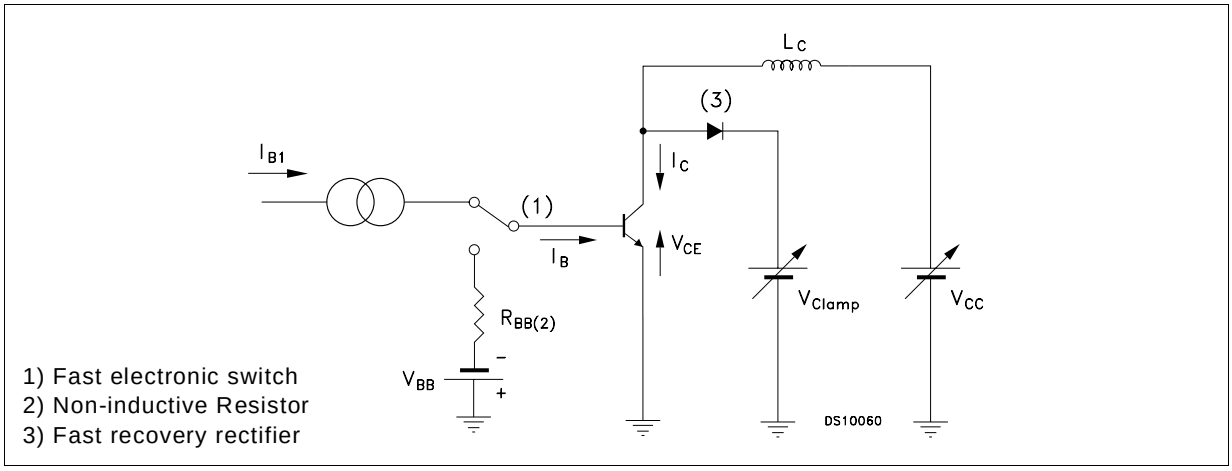
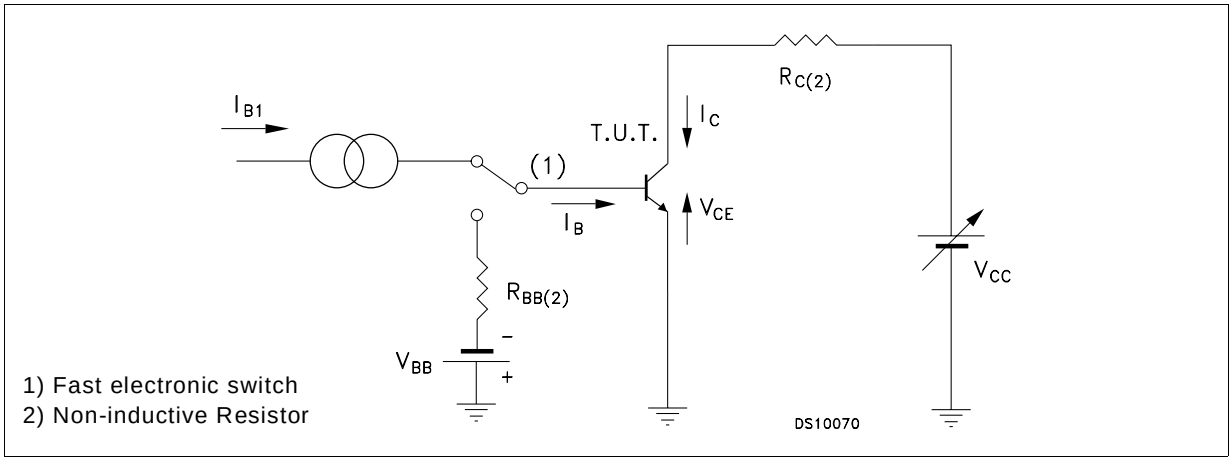
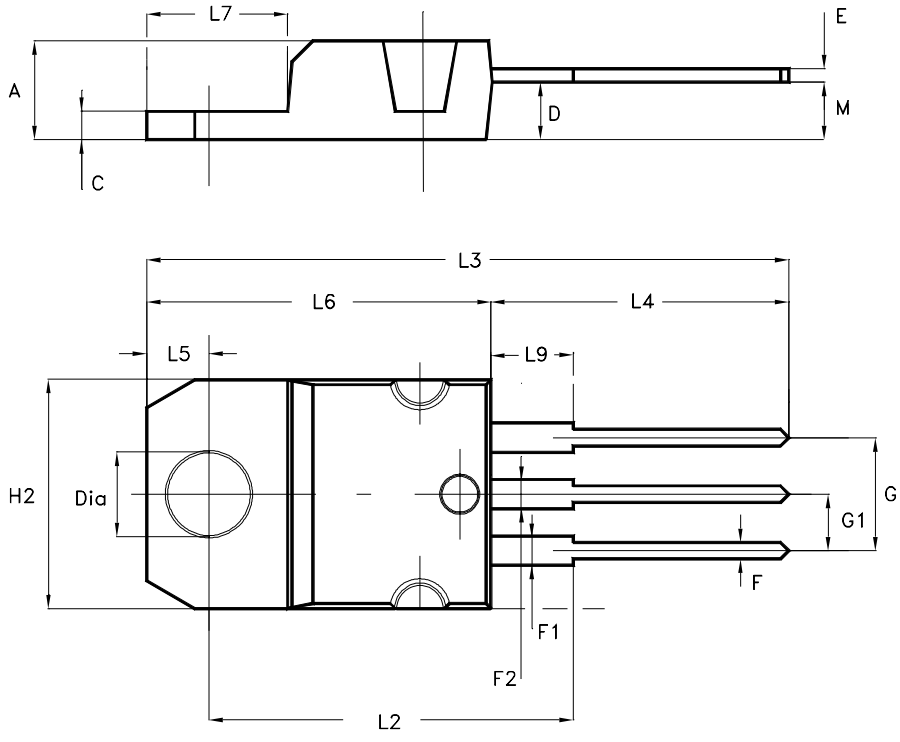


Figure 2: Resistive Load Switching Test Circuit.



TO-220 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
C	1.23		1.32	0.048		0.052
D	2.40		2.72	0.094		0.107
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.202
G1	2.40		2.70	0.094		0.106
H2	10.00		10.40	0.394		0.409
L2		16.40			0.645	
L4	13.00		14.00	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.20		6.60	0.244		0.260
L9	3.50		3.93	0.137		0.154
M		2.60			0.102	
DIA.	3.75		3.85	0.147		0.151



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